Express Mail No. EV335856560US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Fukutomi et al.

Confirmation No.:

9036

10/042,408

Art Unit:

Filed:

January 8, 2002

Examiner: Nema O. Berezny

Attorney Docket No .:

2813

For:

FABRICATION PROCESS OF

SEMICONDUCTOR PACKAGE

AND SEMICONDUCTOR

PACKAGE

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents PO Box 1450

Alexandria, VA 22313-1450Sir:

In accordance with the duty of disclosure provisions of 37 C.F.R. §1.56, there is hereby provided certain information which the Examiner may consider material to the examination of the subject U.S. patent application. It is requested that the Examiner make this information of record if it is deemed material to the examination of the application.

Enclosures accompanying this Information Disclosure Statement are a list of all patents, publications, applications, or other information submitted for consideration by the office and a legible copy of each publication or that portion which caused it to be listed on the PTO-1449;

This Information Disclosure Statement is filed under C.F.R. § 1.97(b) and is filed before the mailing of the First Office Action on its merits.

This application is a continuation application under 37 C.F.R. §1.60 or §1.53(b) or (d). Copies of publications listed on Form PTO-1449 from prior application Serial No. 09/487,682, filed on January 19, 2000 and prior application Serial No. 09/326,316. filed on June 7, 1999, of which this application claims priority under 35 U.S.C. §120, are submitted herewith

The Commissioner is authorized to charge any additional fee required or credit any overpayment for this Information Disclosure Statement and/or Petition to Pennie & Edmonds LLP Deposit Account No. 16-1150.

No admission is made that the information cited in this Statement is, or is considered to be, material to patentability nor a representation that a search has been made (other than a search report of a foreign counterpart application or PCT International Search Report if submitted herewith). 37 C.F.R. §§1.97(g) and (h).

Respectfully submitted,

Date:

August 18, 2003

(Reg. No.)

31,636

By: Steven K. Fukuda (Reg. No. 44,690)

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:

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January 8, 2002

Examiner: Nema O. Berezny

2813

For:

FABRICATION PROCESS OF

Attorney Docket No.:

7426-082

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INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450Sir:

In accordance with the duty of disclosure provisions of 37 C.F.R. §1.56, there is hereby provided certain information which the Examiner may consider material to the examination of the subject U.S. patent application. It is requested that the Examiner make this information of record if it is deemed material to the assessment. is deemed material to the examination of the application.

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AU6 1 9 2003 8					ATTY DOCKET NO. 7426-082-999		APPLICATION NO 10/042,408		
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				FILING DATE January 8, 2002	GROUP 2813				
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*EXAMINER INITIAL	1.00	DOCUMENT NUMBER 4,975,765	DATE 12/04/1990	NAME Ackermann et al.		CLASS	SUBCLASS	FILING I IF APPROF	
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	ASI	110 70/13771	11/13/1790	101/03/0/01828				-	
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XAMINER	DATE CONSIDERED
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^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.